

Instructions for Authors

Submission of Manuscripts

Electronic Materials Letters invites original research reports and review articles related to the topics of electronic, magnetic, and photonic materials.

Submission: Manuscripts prepared either in Korean or English should be submitted online at the journal homepage (<http://www.kim.or.kr>) in the form of a single file containing the following materials in the order shown:

- (1) Title, Authors, Affiliations, Abstract and Keywords
- (2) Main text of the manuscript
- (3) Acknowledgments and References
- (4) Tables captions and Tables, Figure captions and Figures.

The length of a manuscript should not exceed ten journal pages.

Prior publications: Submission of a manuscript is representation that the work reported therein has neither been copyrighted, published, nor submitted for publication elsewhere in any other medium, including electronic journals and computer databases of a public nature. Prior publication is a basis for rejection. Appearance in conference proceedings is not necessarily regarded as a prior publication.

Review Process: Two qualified reviewers, designated by an editor or an associate editor, would judge the submitted manuscript based on its technical merit according to established procedure. The editor makes a final decision on the paper based on the review results within 4 weeks of submission.

The accepted manuscript should carefully be proofread by the authors before publication and will not be returned to the author, unless requested otherwise. The authors are entitled to 20 reprints without additional charge, but are charged for excess reprints exceeding 20 in addition to the nominal publication charge.

Preparation of Manuscripts

The Title should be concise but informative enough to facilitate information retrieval. The first letter of each word should begin with a capital letter except for articles, conjunctions, and prepositions. The first word after a hyphen should also be capitalized such as *Temperature-Dependent Mobility*, *The X-Ray Diffraction*, and *Tin-Lead Solder*.

Bylines should include all those who have made substantial contributions to the work. The first author should be the major contributor of the work. All authors' names should be written in full except for non-Koreans. At least one author should be designated with a sign as the corresponding author.

Affiliations should include the following information in the order of *Institute, Department, City, Zip Code, and Country*.

Abstract should not exceed 150 words. Up to 6 representative **keywords** can be included.

Text should be written as concisely as possible.

- (1) **The International System of Units (SI)** should be employed throughout the text.
- (2) **Abbreviations** should be defined the first time they occur in manuscript. Defined

abbreviations must then be used in the pre-described form.

Example: Absolute temperature (T) is \rightarrow T is

(3) *The mathematical equations* are expressed in italic type, numbering the equations consecutively throughout the text with algebraic numerals in parentheses such as (1), (2), and (3), etc. without connecting lines after the equations.

(4) *Simple equations* can be expressed in one line using slashes with parenthesis,

Example: $\frac{a+b}{c+d}$ can be represented as (a+b)/(c+d).

(5) *Tables and Figures* must be accompanied by the table and figure captions above the describing tables and below the corresponding figures, respectively. The size of figures and photographs should be between 80 and 170 mm in width.

References must be numbered through the manuscript in solid brackets, e.g. [1,2] or [1-6] and presented in consecutive numerical order on the reference page. For the journal abbreviations, refer to table 1 of *Electronic Materials Letters* submission instructions in the journal homepage (<http://www.kim.or.kr>). Type all the references in the corresponding format given below;

(1) **Journals:** Author, Journal Title **Vol.**, page (year).

S. C. Han, D. Y. Yoon, and M. K. Byun, *Electron Mater. Lett.* **43**, 977 (2005).

S. Jin, *Electron. Mater. Lett.* (In press).

(2) **Conference Proceedings or Books:** Author, *Proceeding* (editor) or *Book*, page, publisher, place (year).

T. K. Ha and Y. W. Chang, *Proc. 2nd Pacific Rim Int. Conf. on Adv. Mater. & Processing* (eds. K. S. Shin, J. K. Yoon, and S. J. Kim), p.253, Korean Inst. Metals & Mater., Gyongju, Korea (1995).

D. V. Morgan and K. Board, *An Introduction to Semiconductor Microtechnology, 2nd ed.*, p.1-13, John Wiley & Sons, Chichester (1995).

(3) **Web-page:** Author, *Title*, URL (year).

D. Becker, *The Beowulf Project*, <http://www.beowulf.org> (1994).

(4) **Thesis:** Author, *Thesis*, page, university, place (year).

C.H. Kim, *Ph. D. Thesis*, p. 97-116, Daehan University, Seoul (2004).